





IPM

60

Copper-Clip BOND

MOSFET IPM

2021

2021

2021

~2023

101.17

122.42

146.9

16.98



()	2019	2020	2021E	2022E	2023E	()	2019	2020	2021E	2022E	2023E
:	5,742.8	6,977.3	10,117.0	12,241.6	14,689.9						
	4,431.3	5,060.6	6,616.5	8,018.2	9,636.6		-8.4%	21.5%	45.0%	21.0%	20.0%
	66.2	68.7	99.7	120.6	144.7		-18.4%	124.3%	89.6%	16.6%	18.7%
	112.0	106.0	153.6	185.9	223.1		-6.7%	140.5%	76.3%	16.6%	18.4%
	376.8	369.9	536.4	649.0	778.8	EBITDA	-29.6%	55.5%	73.0%	12.5%	14.6%
	482.6	566.1	809.4	979.3	1,175.2	EBIT	-36.0%	172.6%	140.1%	16.6%	18.7%
	31.0	-119.9	-	-	-	NOPLAT	-3.4%	80.3%	113.4%	16.6%	18.7%
	-36.6	-11.3	-30.0	-30.0	-30.0		-8.4%	1.6%	48.8%	-47.0%	65.2%
:	0.0	1.2	-	-	-		27.3%	84.7%	15.7%	17.1%	

	6-12		300	15%			
	6-12		300	5%	15%		
	6-12		300			-5%	5%
	6-12		300	5%	15%		
	6-12		300	15%			
A	6-12						300
B	6-12						300

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518026	2008	1	7
200080	638	3	
100034	2	15	